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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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## MOS FIELD EFFECT TRANSISTOR

#### SWITCHING N-CHANNEL POWER MOS FET

#### DESCRIPTION

The NP70N10KUF is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
NP70N10KUF-E1-AZ	Pure Sn (Tin)	Tape	TO-263 (MP-25ZK)
NP70N10KUF-E2-AZ		800 p/reel	typ. 1.5 g

Note See "TAPE INFORMATION"

#### FEATURES

- Channel temperature 175 degree rating
- Super low on-state resistance

 $R_{DS(on)} = 20 \text{ m}\Omega \text{ MAX.} (V_{GS} = 10 \text{ V}, \text{ ID} = 35 \text{ A})$ 

• Low Ciss: Ciss = 2500 pF TYP.

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Vdss	100	V
Vgss	±20	V
ID(DC)	±70	А
D(pulse)	±135	А
<b>P</b> T1	1.8	W
Рт2	120	W
Tch	175	°C
Tstg	–55 to +175	°C
AS	22	А
Eas	48	mJ
	VGSS ID(DC) ID(pulse) PT1 PT2 Tch Tstg IAS	VGSS ±20   ID(DC) ±70   ID(pulse) ±135   PT1 1.8   PT2 120   Tch 175   Tstg -55 to +175   IAS 22

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = 50 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20  $\rightarrow$  0 V, L = 100  $\mu$ H

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	1.25	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

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The mark <R> shows major revised points.

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

(TO-263)



CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source Breakdown Voltage	BVDSS	ID = 250 μA, VGs = 0 V	100			V
Zero Gate Voltage Drain Current	IDSS	Vds = 100 V, Vgs = 0 V			10	μA
Gate Leakage Current	lgss	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±100	nA
Gate to Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.7	2.5	3.3	V
Forward Transfer Admittance Note	<b>y</b> fs	Vds = 10 V, Id = 20 A	11	22		S
Drain to Source On-state Resistance Note	RDS(on)	Vgs = 10 V, Id = 35 A		17	20	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = 25 V		2500	3750	pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		270	410	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		110	200	pF
Turn-on Delay Time	td(on)	Vdd = 50 V, Id = 35 A		25	53	ns
Rise Time	tr	Vgs = 10 V		9	23	ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 0 Ω		48	96	ns
Fall Time	tr			7	18	ns
Total Gate Charge	QG	Vdd = 80 V		50	75	nC
Gate to Source Charge	Q <sub>GS</sub>	Vgs = 10 V		16		nC
Gate to Drain Charge	Qgd	ID = 70 A		19		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 70 A, Vgs = 0 V		1.0	1.5	V
Reverse Recovery Time	trr	IF = 70 A, VGS = 0 V		88		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/ <i>µ</i> s		245		nC

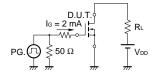
#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

Note Pulsed

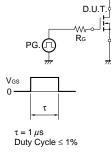
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

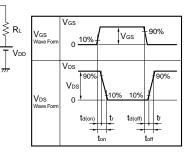
# $V_{GS} = 20 \rightarrow 0 V$ $V_{GS} = 20 \rightarrow 0 V$ $V_{DD}$ $V_{DD$

#### TEST CIRCUIT 3 GATE CHARGE

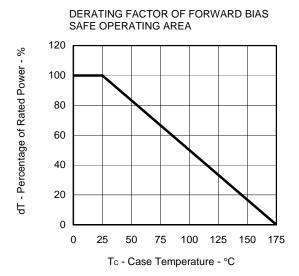


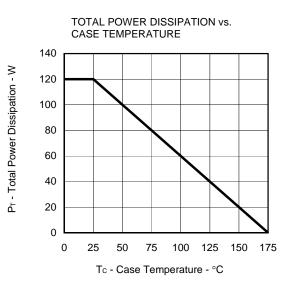
#### TEST CIRCUIT 2 SWITCHING TIME



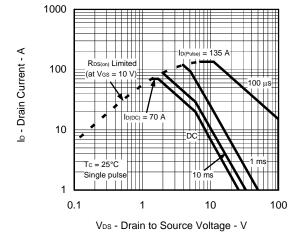


#### TYPICAL CHARACTERISTICS (TA = 25°C)

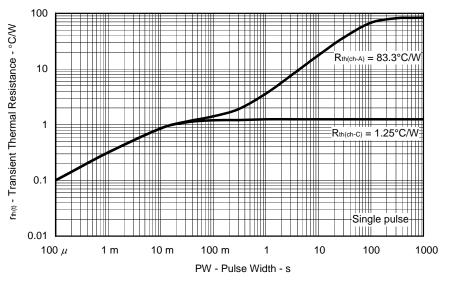




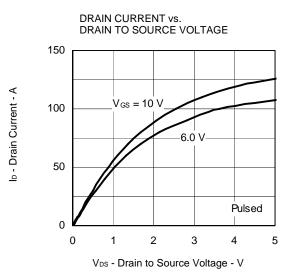
FORWARD BIAS SAFE OPERATING AREA



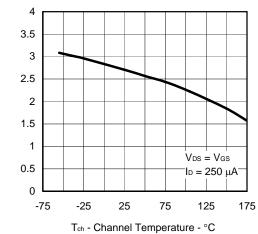
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



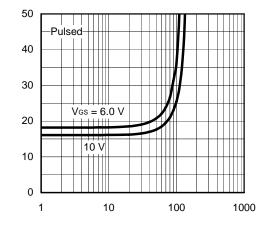
Data Sheet D18040EJ2V0DS



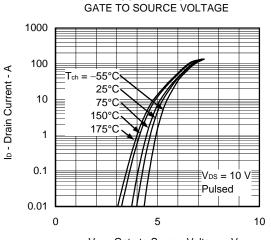




DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



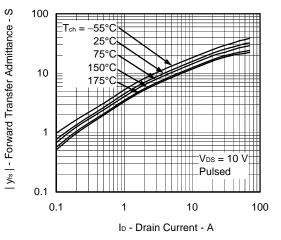
ID - Drain Current - A



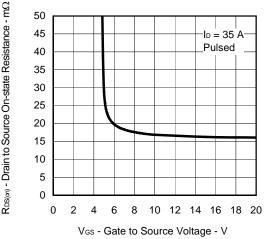
DRAIN CURRENT vs.

V<sub>GS</sub> - Gate to Source Voltage - V

FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



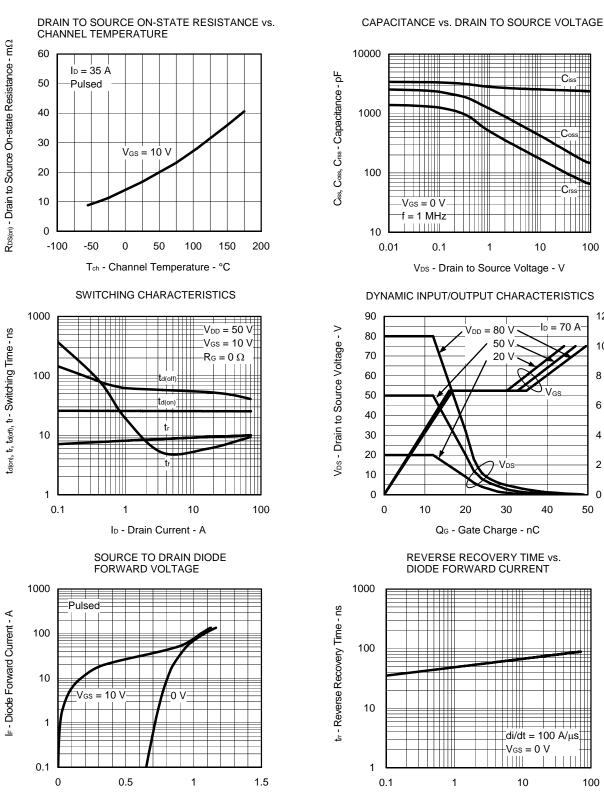
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 $R_{DS(or)}$  - Drain to Source On-state Resistance -  $m\Omega$ 

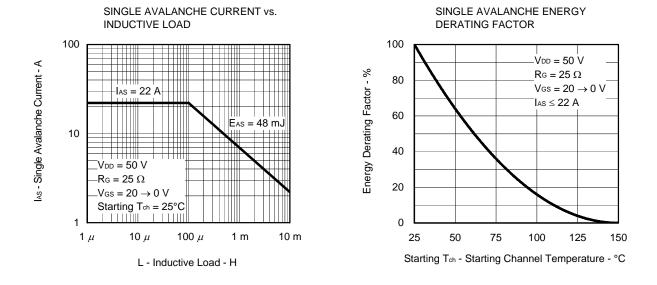
V<sub>GS(th)</sub> - Gate to Source Threshold Voltage - V

V<sub>GS</sub> - Gate to Source Voltage - V



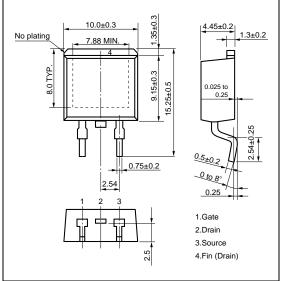
IF - Diode Forward Current - A

VF(S-D) - Source to Drain Voltage - V

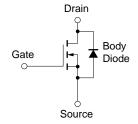


#### PACKAGE DRAWING (Unit: mm)





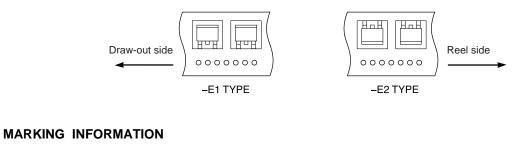
#### EQUIVALENT CIRCUIT

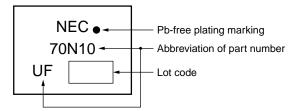


**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

#### <R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.





#### **RECOMMENDED SOLDERING CONDITIONS**

The NP70N10KUF should be soldered and mounted under the following recommended conditions.

For soldering methods and conditions other than those recommended below, please contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below	IR60-00-3
	Time at maximum temperature: 10 seconds or less	
	Time of temperature higher than 220°C: 60 seconds or less	
	Preheating time at 160 to 180°C: 60 to 120 seconds	
	Maximum number of reflow processes: 3 times	
	Maximum chlorine content of rosin flux (percentage mass): 0.2% or less	
Partial heating	Maximum temperature (Pin temperature): 350°C or below	P350
	Time (per side of the device): 3 seconds or less	
	Maximum chlorine content of rosin flux: 0.2% (wt.) or less	

Caution Do not use different soldering methods together (except for partial heating).

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